



(0.635 mm) .025"

MEC6-DV SERIES

VERTICAL MICRO EDGE CARD SO

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?MEC6-DV

Insulator Material: Black LCP

Contact Material: Phosphor Bronze

Plating:
Au or Sn over
50 μ" (1.27 μm) Ni
Operating Temp Range:
-55 °C to +125 °C
-55 °C to +125 °C

Insertion Depth:

(4.22 mm) .166" to (5.66 mm) .223" Current Rating:

2.4 A per pin (2 pins powered) Voltage Rating:

RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (10-50) (0.15 mm) .006" max (60-70)*

(.004" stencil solution may be available: contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

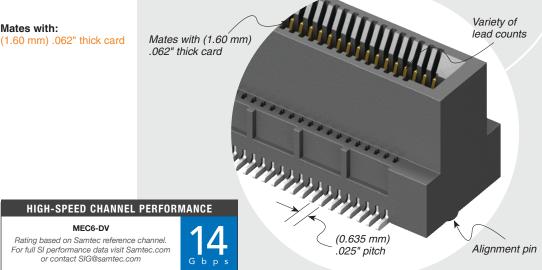
- Locking Clip (Manual placement required)
- · Other platings

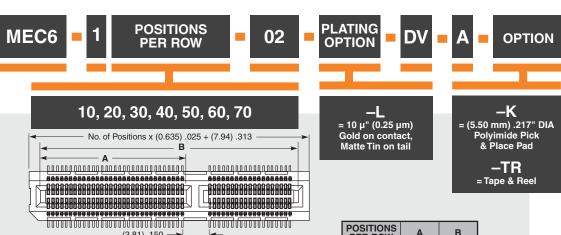
Notes:

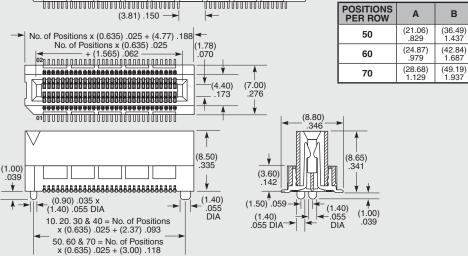
While optimized for $50~\Omega$ applications, this connector with alternative signal/ground patterns may also perform well in certain 75 Ω applications.

Some sizes, styles and options are non-standard, non-returnable.

Mates with:







Due to technical progress, all designs, specifications and components are subject to change without notice